

# **DSA12X2/3/4**

# High Performance Differential MEMS Oscillators for Automotive

#### Features

- Automotive AEC-Q100 Qualified
- Any Frequency between 2.5 MHz and 450 MHz
- Supports LVPECL, LVDS, or HCSL Differential Outputs
- Very Low RMS Phase Jitter: <650 fs (typ.)
- Complies with PCIe Gen1/2/3/4/5/6 Common Clock Spec
- High Stability: ±20 ppm, ±25 ppm, ±50 ppm
- Wide Temperature Range:
  - Automotive Grade 1: -40°C to +125°C (DSA12x3 LVDS Output Only)
  - Automotive Grade 2: -40°C to +105°C
- Automotive Grade 3: -40°C to +85°C
- Small Industry-Standard Footprints
  - 2.5 mm x 2.0 mm
  - 3.2 mm x 2.5 mm
  - 5.0 mm x 3.2 mm
  - 7.0 mm x 5.0 mm
- Excellent Shock and Vibration Immunity
  - Qualified to MIL-STD-883
- High Reliability
  - 20x Better MTF than Quartz Oscillators
- Supply Range of 2.25V to 3.63V
- Standby, Frequency Select, and Output Enable Functions
- · Lead-Free and RoHS-Compliant

#### Applications

- · Automotive Infotainment
- Automotive ADAS
- In-Vehicle Networking, CAN Bus, Ethernet

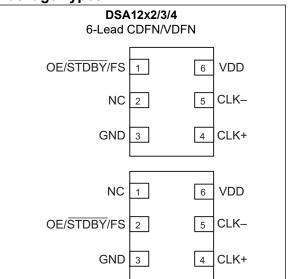
#### **General Description**

The DSA12x2/3/4 family of high performance oscillators utilizes the latest generation of silicon MEMS technology that reduces close-in noise and provides excellent jitter and stability over a wide range of supply voltages and temperatures. By eliminating the need for quartz or SAW technology, MEMS oscillators significantly enhance reliability and accelerate product development, while meeting stringent clock performance criteria for automotive applications.

The DSA12x2/3/4 family features a control function on pin 1 or pin 2 that permits either a standby feature (complete power down when STDBY is low), output enable (output is tri-stated with OE low), or a frequency select (choice of two frequencies selected by FS high/low). See the Product Identification System section for detailed information.

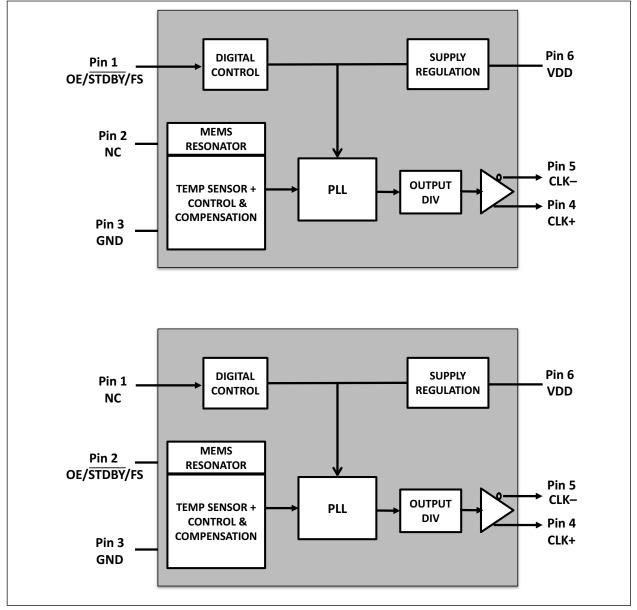
All oscillators are available in industry-standard packages, including the small 2.5 mm x 2.0 mm, and are "drop-in" replacements for standard 6-pin LVPECL/LVDS/HCSL crystal oscillators.

#### **Package Types**



# DSA12X2/3/4

# **Functional Block Diagrams**



# 1.0 ELECTRICAL CHARACTERISTICS

# Absolute Maximum Ratings †

Supply Voltage	
Input Voltage	
ESD Protection (HBM)	20
ESD Protection (MM)	
ESD Protection (CDM)	

**† Notice:** Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational sections of this specification is not intended. Exposure to maximum rating conditions for extended periods may affect device reliability.

# **ELECTRICAL CHARACTERISTICS**

Parameter	Symbol	Min.	Тур.	Max.	Units	Conditions	
Supply Voltage	V <sub>DD</sub>	2.25		3.63	V	Note 1	
		—	50	_		LVPECL, f <sub>OUT</sub> = 100 MHz	
		—	32	—		LVDS, f <sub>OUT</sub> = 100 MHz	
Supply Current	I <sub>DD</sub>	—	40	—	mA	HCSL, f <sub>OUT</sub> = 100 MHz	
		—	23	—		Output disabled (tri-state), f <sub>OUT</sub> = 100 MHz	
Standby Current	I <sub>STDBY_</sub>	_	2.5	5	μΑ	Input pin = STDBY = Asserted (V <sub>DD</sub> = 3.3V)	
				±20		Includes frequency variations due	
Frequency Stability	Δf			±25	ppm	to initial tolerance, temp., and	
		—		±50		power supply voltage	
Aging	Δf	_		±5	ppm	First year @ 25°C	
- Yang	Δι	—		±1	ppin	Per year after first year	
Startup Time	t <sub>SU</sub>	—	5.5	6	ms	From 90% $V_{DD}$ to valid clock output, T = +25°C, Note 2	
less at the size the second	V <sub>IH</sub>	0.75 x V <sub>DD</sub>	—	V		Input logic high	
Input Logic Levels	V <sub>IL</sub>	_		0.25 x V <sub>DD</sub>	V	Input logic low	
Output Disable Time	t <sub>DA</sub>	_		25	ns	Note 3	
Output Enable Time		—		6	ms	STDBY	
	t <sub>EN</sub>	—	—	350	ns	OE	
Enable Pull-Up Resistor	—	—	1.5	—	MΩ	Pull-up resistor on pin 1, Note 4	
LVPECL (DSA12x2)							
Frequency	f <sub>0</sub>	2.5		450	MHz	_	
Output Logic Levels	V <sub>OH</sub>	V <sub>DD</sub> – 1.145	—	—	V	R <sub>1</sub> = 50Ω	
Output Logic Levels	V <sub>OL</sub>	_	—	V <sub>DD</sub> – 1.695	v	11 <u>- 303</u>	
Peak-to-Peak Output Swing	V <sub>PP</sub>		800		mV	Single-Ended	
Output Transition Time	t <sub>R</sub>	—	200	250	ps	20% to 80%, $R_1 = 50\Omega$	
	t <sub>F</sub>	_	250	300	ha	$20\% 1000\%$ , $R_{L} = 5002$	

# **ELECTRICAL CHARACTERISTICS (CONTINUED)**

**Electrical Characteristics:**  $V_{DD} = 2.5V \pm 10\%$  or  $3.3V \pm 10\%$ ;  $T_A = -40^{\circ}C$  to  $\pm 105^{\circ}C$ , unless noted.

Parameter	Symbol	Min.	Тур.	Max.	Units	Conditions
Output Duty Cycle	SYM	48		52	%	Differential
Period Jitter RMS	J <sub>PER</sub>		2.0		ps	f <sub>0</sub> = 156.25 MHz, 10k cycles
Period Jitter Peak-to-Peak	J <sub>PTP</sub>		20		ps	f <sub>0</sub> = 156.25 MHz, 10k cycles
Integrated Phase Noise (Random)	J <sub>PH</sub>	_	0.65		ps <sub>RMS</sub>	12 kHz to 20 MHz @156.25 MHz
LVDS Integrated Phase Nois	e (DSA12x3)	)				
Frequency	f0	2.3	_	450	MHz	—
Output Offset Voltage	V <sub>OS</sub>	1.15	1.25	1.35	V	R = 100Ω Differential
Peak-to-Peak Output Swing	V <sub>PP</sub>	250	350	450	mV	Single-Ended
Output Transition Time	t <sub>R</sub>	120	170	220	ne	20% to 80%, R <sub>I</sub> = 100Ω
	t <sub>F</sub>	120	170	220	ps	20% to 80%, KL = 10022
Output Duty Cycle	SYM	48	—	52	%	Differential
Period Jitter RMS	J <sub>PER</sub>	—	2.5	—	ps	f <sub>0</sub> = 156.25 MHz, 10k cycles
Period Jitter Peak-to-Peak	J <sub>PTP</sub>	_	20	—	ps	f <sub>0</sub> = 156.25 MHz, 10k cycles
Period Jitter RMS	J <sub>PER</sub>	_	3		ps	f <sub>0</sub> = 156.25 MHz, T <sub>A</sub> = -40°C to +125°C
Period Jitter Peak-to-Peak	J <sub>PTP</sub>		25		ps	f <sub>0</sub> = 156.25 MHz, T <sub>A</sub> = -40°C to +125°C
Integrated Phase Noise		_	0.65	_		12 kHz to 20 MHz @156.25 MHz T <sub>A</sub> = -40°C to +105°C
(Random)	J <sub>PH</sub>	_	0.9	_	ps <sub>RMS</sub>	2 kHz to 20 MHz @156.25 MHz TA = -40°C to +125°C
Phase Jitter	J <sub>RMS-CC</sub>	_	0.025	0.1	ps <sub>RMS</sub>	PCIe Gen 6.0, 64 GT/s
HCSL (DSA12x4)						1
Frequency	f <sub>0</sub>	2.3	_	450	MHz	—
	V <sub>OH</sub>	0.64	_	_		5 500
Output Logic Levels	V <sub>OL</sub>	_	—	0.1	V	R <sub>L</sub> = 50Ω
Peak-to-Peak Output Swing	V <sub>PP</sub>	_	750	_	mV	Single-Ended
	t <sub>R</sub>	200	260	400		000/ 1 000/ 5 500
Output Transition Time	t <sub>F</sub>	250	370	500	ps	20% to 80%, $R_L = 50\Omega$
Output Duty Cycle	SYM	48	_	52	%	Differential
Period Jitter RMS	J <sub>PER</sub>		2		ps	f <sub>0</sub> = 100.00 MHz, 10k cycles
Period Jitter Peak-to-Peak	J <sub>PTP</sub>		16		ps	f <sub>0</sub> = 100.00 MHz, 10k cycles
		_	0.617			12 kHz to 20 MHz @100 MHz
Integrated Phase Noise (Random)	J <sub>PH</sub>		0.460		ps <sub>RMS</sub>	100 kHz to 20 MHz @100 MHz
			0.212		1	1.875 MHz to 20 MHz @100 MH

# **ELECTRICAL CHARACTERISTICS (CONTINUED)**

**Electrical Characteristics:**  $V_{DD}$  = 2.5V ±10% or 3.3V±10%;  $T_A$  = -40°C to +105°C, unless noted.

Parameter	Symbol	Min.	Тур.	Max.	Units	Conditions
	TJ		23	86	ps <sub>PP</sub>	PCle Gen 1.1, $T_J = D_J + 14.069 x$ $R_J$ (BER 10 <sup>-12</sup> ), Note 5
	J <sub>RMS-CCHF</sub>	_	2.230	3.1	ps <sub>RMS</sub>	PCIe Gen 2.1, 1.5 MHz to Nyquist, Note 5
Phase Jitter	J <sub>RMS-CCLF</sub>	_	0.08	3.0	ps <sub>RMS</sub>	PCIe Gen 2.1, 10 kHz to1.5 MHz, Note 5
		—	0.107	1.0		PCIe Gen 3.0, Note 5
	J <sub>RMS-CC</sub>	—	0.107	0.30		PCle Gen 4.0, 16 GT/s
		_	0.043	0.12	ps <sub>RMS</sub>	PCle Gen 5.0, 32 GT/s
			0.054	0.1		PCIe Gen 6.0, 64 GT/s

Note 1:  $V_{DD}$  pin should be filtered with a 0.1  $\mu$ F capacitor.

- **2:**  $t_{SU}$  is the time to 100 ppm stable output frequency after V<sub>DD</sub> is applied and outputs are enabled.
- 3: t<sub>DA</sub>: See the Output Waveform and the Test Circuits sections for more information.
- 4: Output is enabled if pad is floated (not connected).
- 5: Jitter limits established by Gen1.1, Gen 2.1, and Gen 3.0 PCIe standards.

# **TEMPERATURE SPECIFICATIONS Note 1**

Parameters	Symbol	Min.	Тур.	Max.	Units	Conditions
Temperature Ranges						
Maximum Junction Temperature	TJ	_	_	+150	°C	—
Storage Temperature Range	T <sub>S</sub>	-55		+150	°C	—
Lead Temperature	—		_	+260	°C	Soldering, 40s

**Note 1:** The maximum allowable power dissipation is a function of ambient temperature, the maximum allowable junction temperature and the thermal resistance from junction to air (i.e., T<sub>A</sub>, T<sub>J</sub>, θ<sub>JA</sub>). Exceeding the maximum allowable power dissipation will cause the device operating junction temperature to exceed the maximum +150°C rating. Sustained junction temperatures above +150°C can impact the device reliability.

# 2.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in Table 2-1.

#### TABLE 2-1: DSA120X/1X/2X PIN FUNCTION TABLE

Pin Number	Pin Name	Description
1	OE/STDBY/FS	Control pin: Output enable/standby/frequency select. External 10 k $\Omega$ pull up recommended when not actively driven.
2	NC	No connect.
3	GND	Power supply ground.
4	CLK+	Clock output +.
5	CLK–	Clock output –.
6	VDD	Power supply.

#### TABLE 2-2: DSA123X/4X/5X PIN FUNCTION TABLE

Pin Number	Pin Name	Description
1	NC	No connect.
2	OE/STDBY/FS	Control pin: Output enable/standby/frequency select. External 10 k $\Omega$ pull up recommended when not actively driven.
3	GND	Power supply ground.
4	CLK+	Clock output +.
5	CLK–	Clock output –.
6	VDD	Power supply.

# 3.0 TERMINATION SCHEME

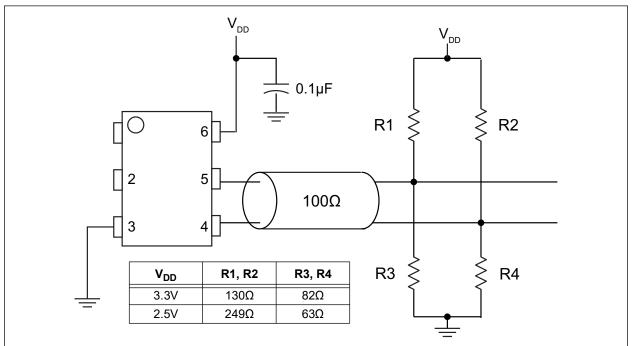
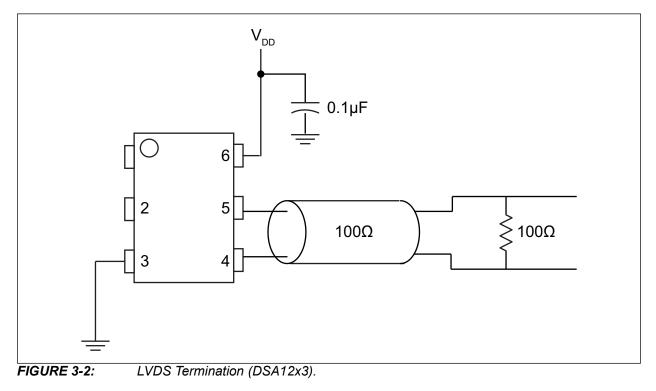
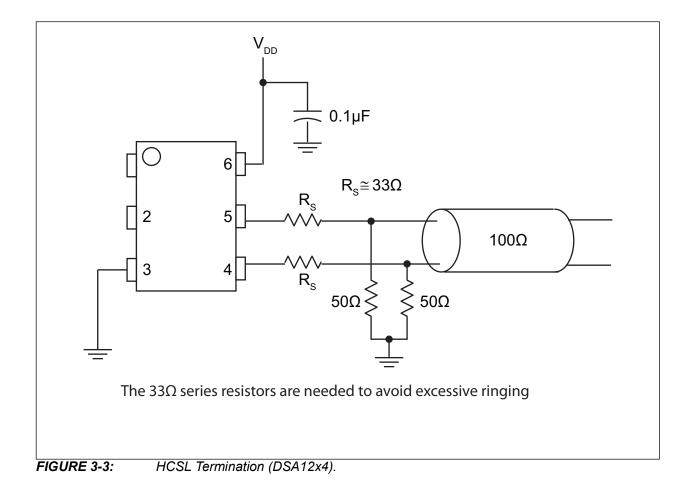


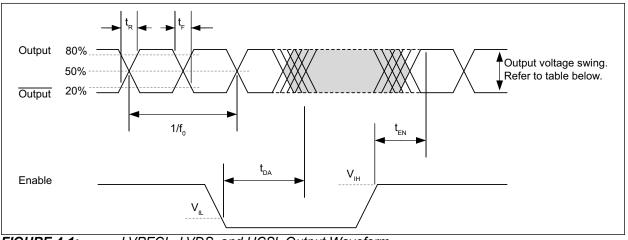
FIGURE 3-1: LVPECL Termination (DSA12x2).

In Figure 3-1, Thevenin termination for 3.3V operation. Values will differ for  $V_{DD}$  = 2.5V.





### 4.0 OUTPUT WAVEFORM



# FIGURE 4-1: LVPECL, LVDS, and HCSL Output Waveform.

### TABLE 4-1: OUTPUT VOLTAGE SWING BY LOGIC TYPE

Output Logic Protocol	Typical Peak-to-Peak Output Swing
LVPECL	830 mV
LVDS	350 mV
HCSL	675 mV

# 5.0 TEST CIRCUITS

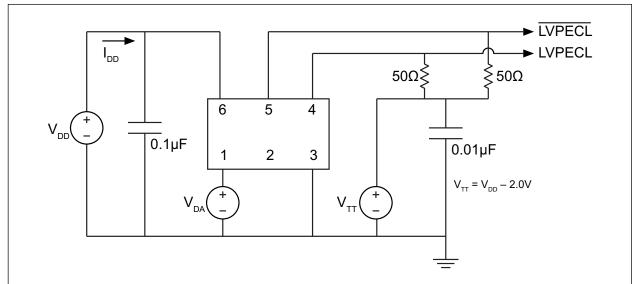


FIGURE 5-1: LVPECL Test Circuit.

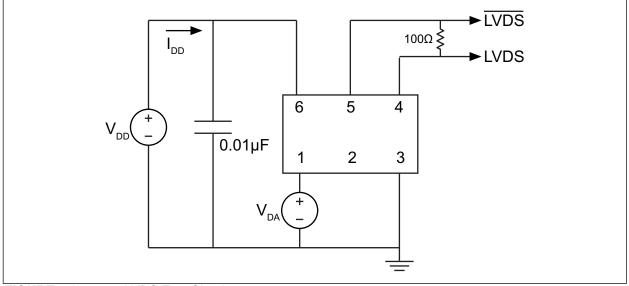


FIGURE 5-2: LVDS Test Circuit.

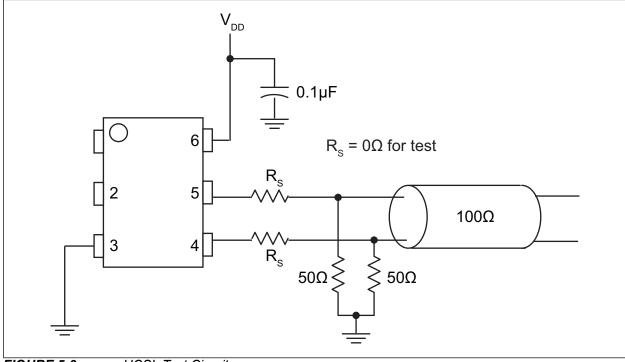
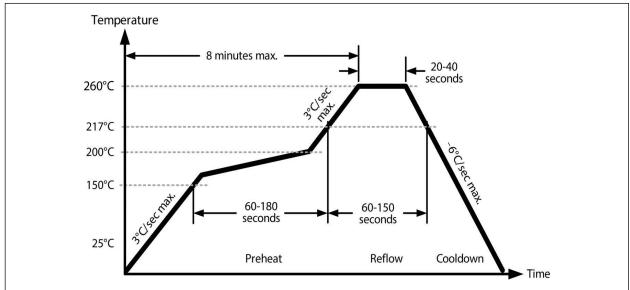
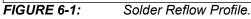


FIGURE 5-3:

HCSL Test Circuit.

# 6.0 SOLDER REFLOW PROFILE

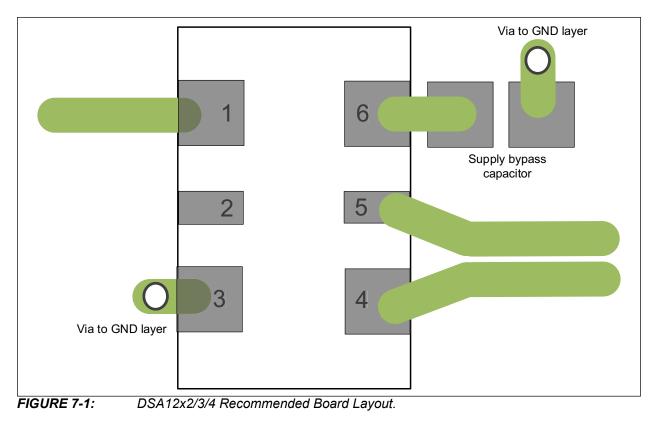




#### TABLE 6-1: SOLDER REFLOW

MSL 1 @ 260°C Refer to JSTD-020C								
Ramp-Up Rate (200°C to Peak Temp.)	3°C/sec. max.							
Preheat Time 150°C to 200°C	60 to 180 sec.							
Time Maintained above 217°C	60 to 150 sec.							
Peak Temperature	255°C to 260°C							
Time within 5°C of Actual Peak	20 to 40 sec.							
Ramp-Down Rate	–6°C/sec. max.							
Time 25°C to Peak Temperature	8 minutes max.							

# 7.0 BOARD LAYOUT (RECOMMENDED)



# 8.0 PHASE NOISE

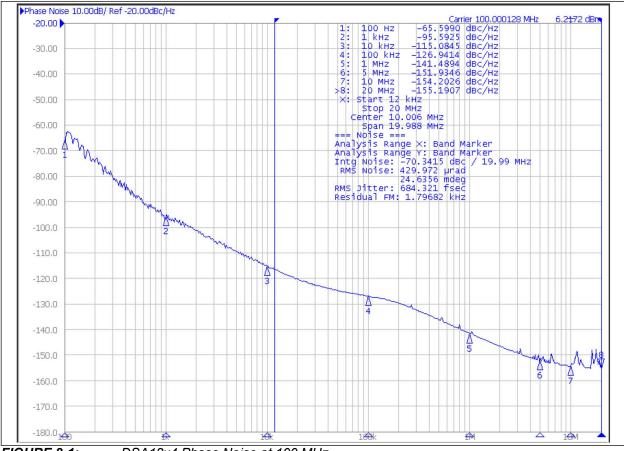


FIGURE 8-1: DSA12x4 Phase Noise at 100 MHz.

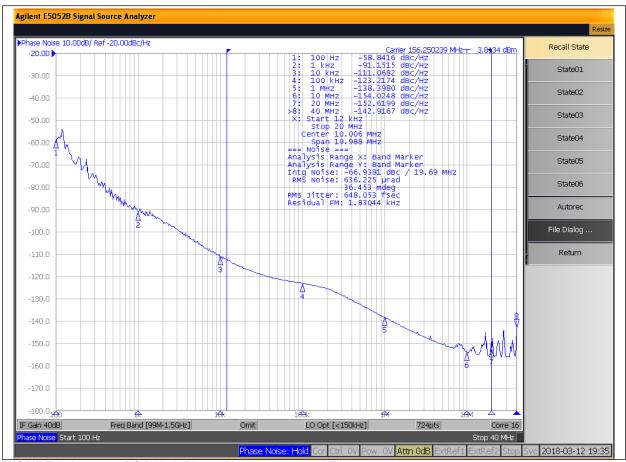
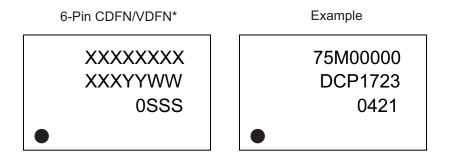


FIGURE 8-2: DSA12x2 Phase Noise at 156.25 MHz.

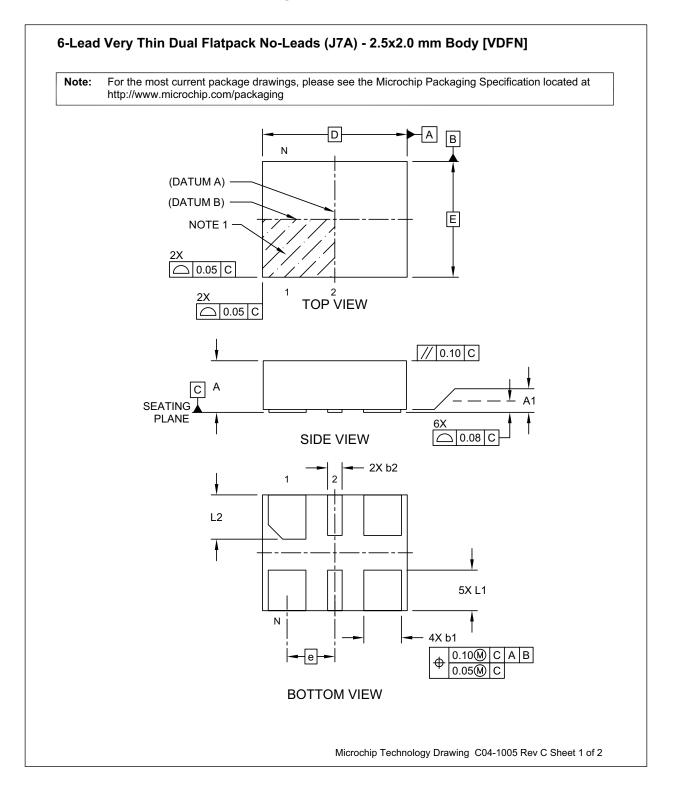
# 9.0 PACKAGING INFORMATION

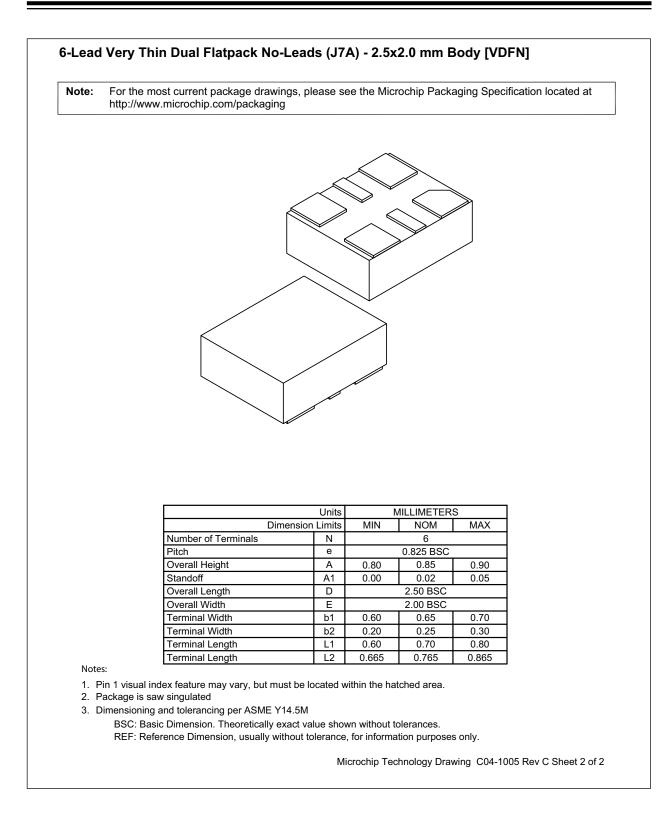
# 9.1 Package Marking Information

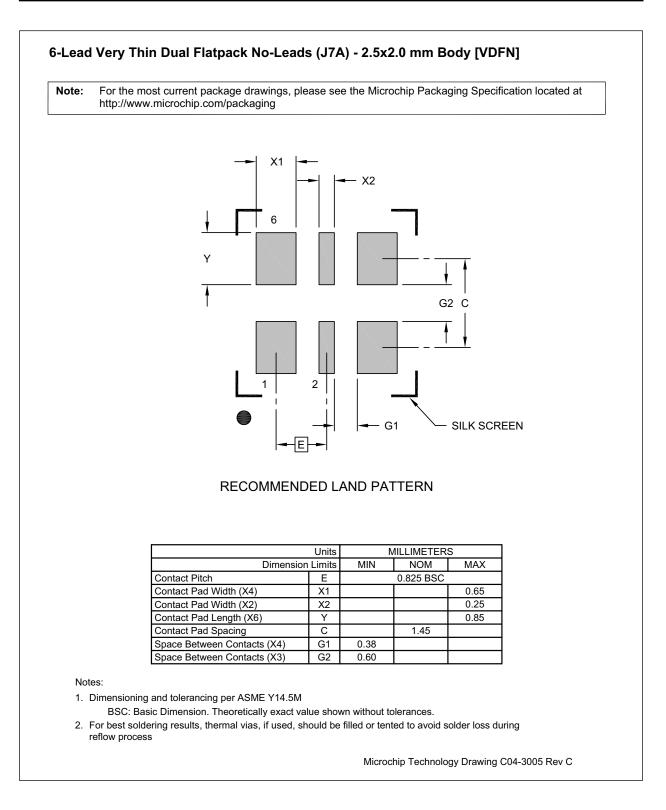


Legend	Y YY WW SSS @3 *	Product code or customer-specific information Year code (last digit of calendar year) Year code (last 2 digits of calendar year) Week code (week of January 1 is week '01') Alphanumeric traceability code Pb-free JEDEC <sup>®</sup> designator for Matte Tin (Sn) This package is Pb-free. The Pb-free JEDEC designator ((e3)) can be found on the outer packaging for this package. Pin one index is identified by a dot, delta up, or delta down (triangle
Note:	be carried	nt the full Microchip part number cannot be marked on one line, it will d over to the next line, thus limiting the number of available for customer-specific information. Package may or may not include ate logo.
	Underbar	(_) and/or Overbar ( <sup>-</sup> ) symbol may not be to scale.

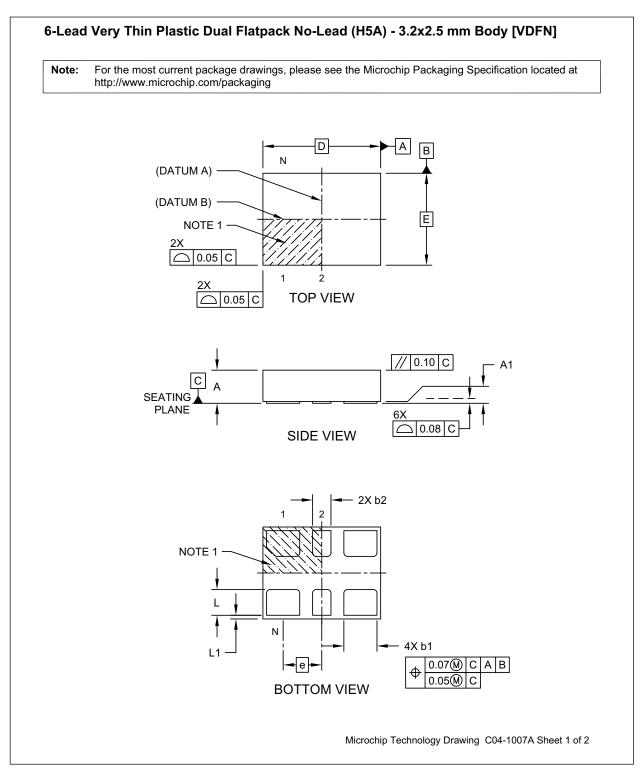
# 6-Lead VDFN 2.5 mm x 2.0 mm Package Outline and Recommended Land Pattern

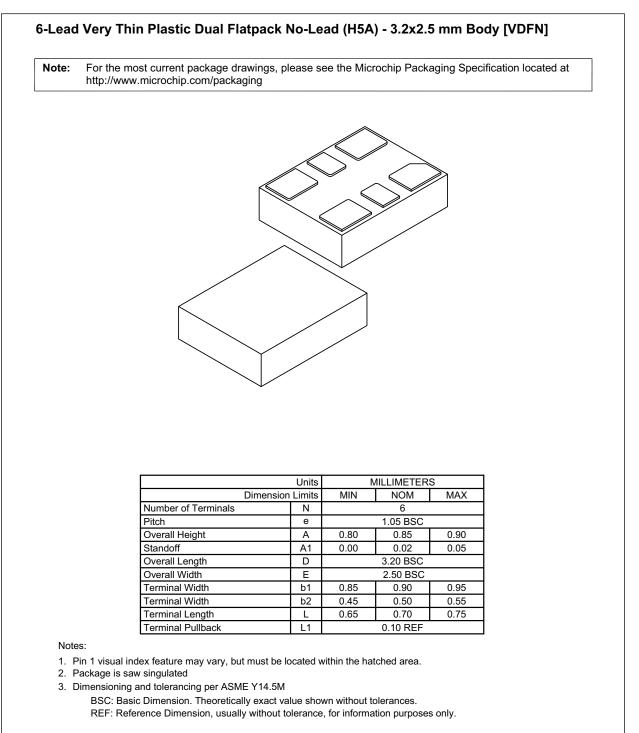




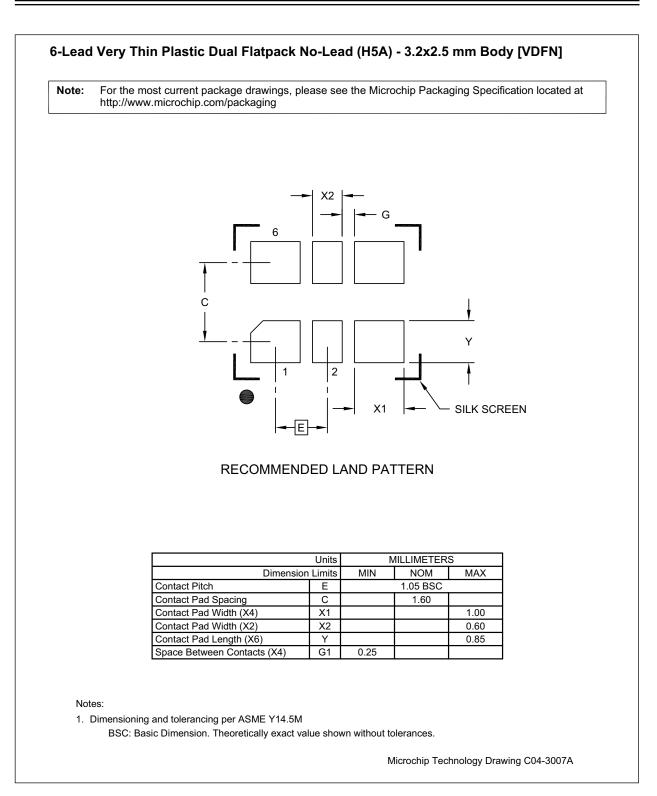


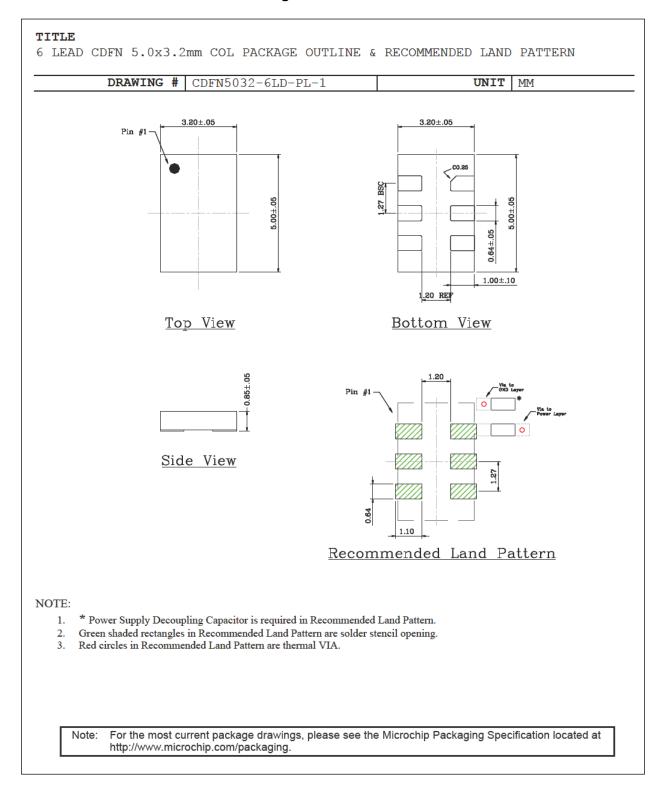
#### 6-Lead VDFN 3.2 mm x 2.5 mm Package Outline and Recommended Land Pattern





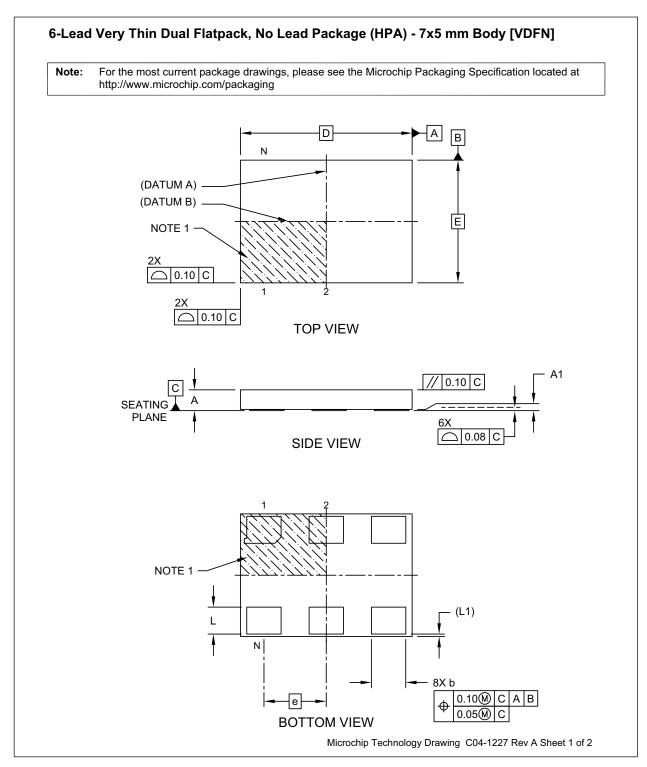
Microchip Technology Drawing C04-1007A Sheet 2 of 2

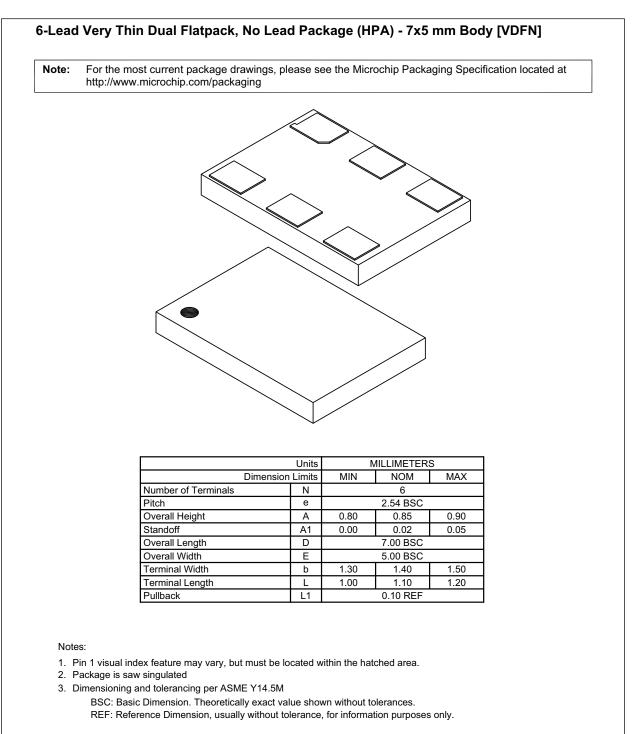




#### 6-Lead CDFN 5.0 mm x 3.2 mm Package Outline and Recommended Land Pattern

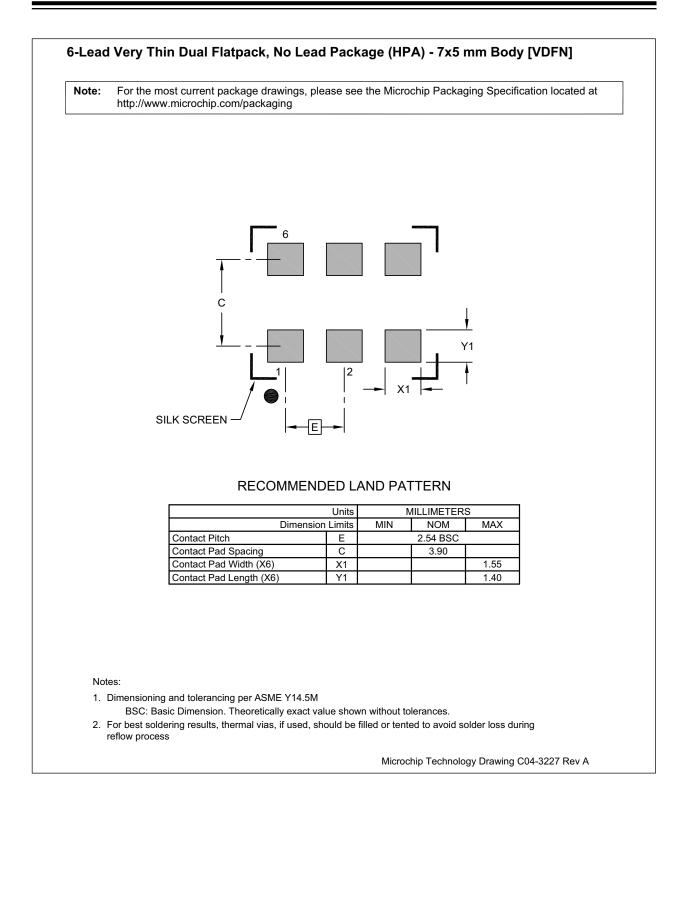
### 6-Lead VDFN 7.0 mm x 5.0 mm Package Outline and Recommended Land Pattern





Microchip Technology Drawing C04-1227 Rev A Sheet 2 of 2

# DSA12X2/3/4



# APPENDIX A: REVISION HISTORY

#### Revision A (June 2020)

• Initial release of DSA12x2/3/4 as Microchip data sheet DS20006378A.

#### **Revision B (March 2021)**

- Updated Phase Jitter maximum values for J<sub>RMS-CC</sub> in the Electrical Characteristics table and added a sixth note.
- Updated package drawing for 6-Lead VDFN 2.5 mm x 2.0 mm Package Outline and Recommended Land Pattern.
- Updated Figure 3-1.

#### Revision C (March 2021)

• Removed Note 6 from the Electrical Characteristics table.

# Revision D (May 2023)

- Updated the Features list to include PCIe Gen 6.
- Added Phase Jitter values for PCI Gen 6 to the LVDS and HCSL sections of the Electrical Characteristics table.

# DSA12X2/3/4

NOTES:

# **PRODUCT IDENTIFICATION SYSTEM**

To order or obtain information, e.g., on pricing or delivery, contact your local Microchip representative or sales office.

PART NO.	X	×	×	×		<u>X</u>		<u>-X</u>	<u>XXXXXXX</u>	¥	<u>xxx</u>	
Device Co F	ntrol Pin		•	Temperat	ture Fr	req. St	ability	Outpu	ut Frequency	Media Type	Automotive Suffix	
Device:	DS.	A12:	High Performar Oscillators for		IMEMS			xample DSA1:	202NI1-25M000 Pull-up, LV	PECL Ou	Pin 1 STDBY wit tput, 7x5 VDFN pm, 25 MHz Outpu	
Control Pin:	0 1 2 3 4 5		Pin 2 Frequency	Select with Pu III-up h PuII-up Select with Pu					Frequency, 1 243CL3-C0013 with Pull-up, -40°C to +1 Frequency, B	,000/Reel, S /AO: Pin 2 LVDS Out 05°C, ±20 p ulk, Standar	tandard Automotive Prequency Sele- put, 3.2x2.5 VDFt pm, Multiple Output d Automotive	
Output Format:	2 3 4	= = =	LVPECL LVDS HCSL						HCSL Output ±25 ppm, 1 3,000/Reel, S	t, 5x3.2 CDI I9.5 MHz Standard Aut		
Package:	N B C D	= = =	7 mm x 5 mm 6- 5 mm x 3.2 mm ( 3.2 mm x 2.5 mn 2.5 mm x 2 mm (	6-Lead CDFN n 6-Lead VDF	N				Pull-up, LVI –40°C to +10 Frequency, 1	000TVAO: Pin 2 STDBY PECL Output, 2.5x2 V J5°C, ±20 ppm, 55.82 MHz C ,000/Reel, Standard Autom 3VAO: Pin 1 Frequency S b, LVDS Output, 7x5 V 35°C, ±50 ppm, Multiple C 9,000/Reel, Standard Autom		
Temperature:	A L I	= = =	-40°C to +125°C -40°C to +105°C -40°C to +85°C	(Grade 2)					–40°C to +8			
Frequency Stability:	1 2 3	= = =	±50 ppm ±25 ppm ±20 ppm				N	ote 1:	catalog part nur used for orderin the device pack	dentifier only appears in the nber description. This identifier g purposes and is not printed c age. Check with your Microchip package availability with the		
Output Frequency	xxN xxx CC	/xxxxx=	<100 MHz >100 MHz	Select					Tape and Reel			
Media Type:	  T B	ank>= = =	Bulk 1,000/Reel 3,000/Reel									
Automotive Suffix	: VX		ochip. Default valu				0-					
Please visit the configure the pa												
http://clockwork							-					

# DSA12X2/3/4

NOTES:

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ISBN: 978-1-6683-2580-3

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